

Designation: B539 - 20

# Standard Test Methods for Measuring Resistance of Electrical Connections (Static Contacts)<sup>1</sup>

This standard is issued under the fixed designation B539; the number immediately following the designation indicates the year of original adoption or, in the case of revision, the year of last revision. A number in parentheses indicates the year of last reapproval. A superscript epsilon  $(\varepsilon)$  indicates an editorial change since the last revision or reapproval.

### 1. Scope

- 1.1 These test methods cover equipment and techniques for measuring the resistance of static electrical connections such as wire terminations or splices, friction connectors, soldered joints, and wrapped-wire connections.
- 1.2 Measurements under two distinct levels of electrical loading are described. These levels are: (1) dry circuit, (2) and rated current. One or both of these levels of loading may be required in specific cases.
- 1.3 This standard does not purport to address all of the safety concerns, if any, associated with its use. It is the responsibility of the user of this standard to become familiar with all hazards including those identified in the appropriate Safety Data Sheet (SDS) for this product/material as provided by the manufacturer, to establish appropriate safety, health, and environmental practices, and determine the applicability of regulatory limitations prior to use.
- 1.4 This international standard was developed in accordance with internationally recognized principles on standardization established in the Decision on Principles for the Development of International Standards, Guides and Recommendations issued by the World Trade Organization Technical Barriers to Trade (TBT) Committee.

### 2. Referenced Documents

- 2.1 ASTM Standards:<sup>2</sup>
- B542 Terminology Relating to Electrical Contacts and Their
- E122 Practice for Calculating Sample Size to Estimate, With Specified Precision, the Average for a Characteristic of a Lot or Process

### 3. Terminology

- 3.1 *Definitions:*
- 3.1.1 See Terminology B542 for definitions of contact resistance, film resistance, and constriction resistance.
- 3.1.2 bulk resistance, n—the resistance a contact assembly would have if it were solid metal of an identical geometry so that the nominal contact area offered zero resistance. When measuring contact resistance one attempts to include as little bulk resistance as possible in the measurement, by placing measuring probes as close to the contact interface as practical.
- 3.1.3 connection resistance, n—the resistance from the termination point on one end of a device containing static contacts, through the contacts to the termination point on the other end of the device. The termination point is the location on a terminal of a device where a wire or printed circuit path electrically connects to the terminal. This resistance is the value of resistance displayed by the device in a circuit application.
- 3.1.3.1 *Discussion*—The term contact resistance is often used in commercial literature to indicate the connection resistance displayed by the device in a standard application. In the more rigorous usage of contact resistance, the connection resistance is the sum of the contact resistance plus the bulk resistance of leads within the device that go to the static contacts from the point that the leads are connected to the external circuitry. Measurement of contact resistance independent of all bulk resistance is very difficult for most commercial devices.
- 3.1.4 dry circuit, n—a circuit in which the open-circuit voltage is less than or equal to 20 mV. Current is usually low in a dry circuit, but a low-current circuit is not necessarily a dry circuit. When the applied voltage (open-circuit voltage) is too low to cause any physical changes in the contact junction, such as break-down of thin insulating films or softening of contact asperities, the circuit is said to be a dry circuit.
- 3.1.5 *open-circuit voltage*, *n*—the steady-state voltage which would appear across the contacts if they were opened.
- 3.1.6 *static contacts, n*—electric junctions designed for infrequent separation and connection, and intended to perform their function only when contacting members are stationary relative to each other. This definition includes crimped,

<sup>&</sup>lt;sup>1</sup> These test methods are under the jurisdiction of ASTM Committee B02 on Nonferrous Metals and Alloys and are the direct responsibility of Subcommittee B02.11 on Electrical Contact Test Methods.

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<sup>&</sup>lt;sup>2</sup> For referenced ASTM standards, visit the ASTM website, www.astm.org, or contact ASTM Customer Service at service@astm.org. For *Annual Book of ASTM Standards* volume information, refer to the standard's Document Summary page on the ASTM website.

welded, brazed, riveted, or soldered joints; friction connections such as pin and socket connectors or taper pins, twisted-wire splices; and connections made with screws, or bolts and nuts between electrical wiring and components. The definition excludes relay contacts, slip rings and commutators, and switches and circuit breakers.

3.2 Descriptions of Terms for Levels of Electrical Loading:

3.2.1 dry circuit, n—This method provides for measurement of contact resistance under very low levels of electrical excitation, with applied voltages and currents selected to be too low to cause breakdown of thin oxide films or other contaminates in the contact interface or to cause formation of metallic bridges across the interface where none may otherwise exist. Dry circuit testing is intended to determine whether the test contact will function properly in circuits of arbitrarily low levels of electrical excitation. Dry circuit testing procedures should be used when the possibility of films or contaminants in the contact interface exists or when the test sample is ultimately intended for use in a low-level circuit. This testing must precede other tests on the same samples at high levels of electrical loading.

3.2.2 rated current, n—The rated current for a static contact device is determined or specified by the vendor or user of the device. The rated current may be large enough to cause significant heating of the test samples. When rated current measurements of contact resistance are required, using either ac or dc test currents, the procedures outlined for temperature stabilization in 9.5.3 must be followed.

# 4. Summary of Test Methods

- 4.1 The test methods described herein are characterized as four-terminal resistance measuring techniques, wherein a measured and controlled test current is introduced into the sample using two" terminals" or connecting points, and two other points are selected on the sample across which a voltage drop is measured. This voltage drop, divided by the test current, is the effective overall resistance of the sample included between the voltage probes. The voltage-measuring points are chosen so as to measure as closely as possible the voltage drop due only to the contact resistance of the sample and to eliminate from the measurement as much as possible the resistance of the metal pieces comprising the contact and the resistance of the wires and connections used to introduce the test current into the sample.
- 4.2 Two different levels of test current are specified. The choice of which level to use is governed by the application and requirements of the electrical connection being tested. Electronic signal-circuit connections may require low-level (dry-circuit) testing, whereas power-handling wire connectors should be tested at rated current.
- 4.3 Either ac or dc test currents may be used, with appropriate instrumentation.

### 5. Significance and Use

5.1 As stated in Terminology B542, contact resistance is comprised of a constriction resistance and a film resistance. When present, the latter of these is usually much greater in

value and dominates the contact resistance. For a given contact spot, when the film resistance is zero or negligible the contact resistance for that spot is nearly the same as the constriction resistance and therefore, as a practical matter, has a minimum value which represents a clean metal-to-metal contact spot. As real contact surfaces exhibit varying degrees of roughness, real contacts are necessarily composed of many contact spots which are electrically parallel. In practical cases the clean metal-tometal contact spots will carry most of the current and the total contact resistance is primarily dependent on the size and number of metallic contact spots present (see Note 1). In addition, acceptably low values of contact resistance are often obtained with true areas of contact being significantly less than the apparent contact area. This is the result of having a large number of small contact spots spread out over a relatively large apparent contact area.

Note 1—The term metallic contact as used here is intended to include the so called quasi-metallic contact spots as well. The latter case was discussed in  $Electric\ Contacts$  by Holm.  $^3$ 

5.2 The practical evaluation and comparison of electrical connections depend in large part on their contact resistance characteristics. On the one hand, the absolute value of contact resistance is greatly dependent on the size and distribution of the metallic conducting spots within the apparent area of load-bearing contact. On the other hand, a comparison of the initial resistance to the resistance after aging indicates how stable the system is in maintaining the initial contact area. Both of these characteristics should be considered when evaluating contact systems. The criteria employed in evaluating contact resistance and stability are not a part of these test methods as they depend on specific applications and therefore, will not be quantitatively stated. However, an estimate of contact resistance<sup>3</sup> resulting from good metallic contact can be made for a given physical situation and used as a comparison to actual measurements to determine how effective the system is in establishing stable metallic contact. Resistances measured by these methods before, during and after simulated life tests are used as a means of determining the stability of contacts within a device.

## 6. Interferences

- 6.1 Measurement of Low Resistance:
- 6.1.1 Contact resistances are normally very small, ranging from microohms to a few milliohms in cases of practical interest. The measurement of resistance in this range requires special techniques to eliminate effects of thermal potentials, external interference, and resistance of connections and wires leading to the test sample.
- 6.1.2 The resistance-measuring procedures in these test methods are four-terminal techniques. Test current in the sample is measured and controlled, and made independent of the sample resistance. Voltage-measuring probes are attached to the sample so as to eliminate the effects of connections of the sample into the test circuit. If the purpose of the measurement

<sup>&</sup>lt;sup>3</sup> Calculations and formulae for contact resistance of various types of contacts are covered very thoroughly in Holm's *Electric Contacts*, 4th Edition, Springer-Verlag, New York.